

Description:

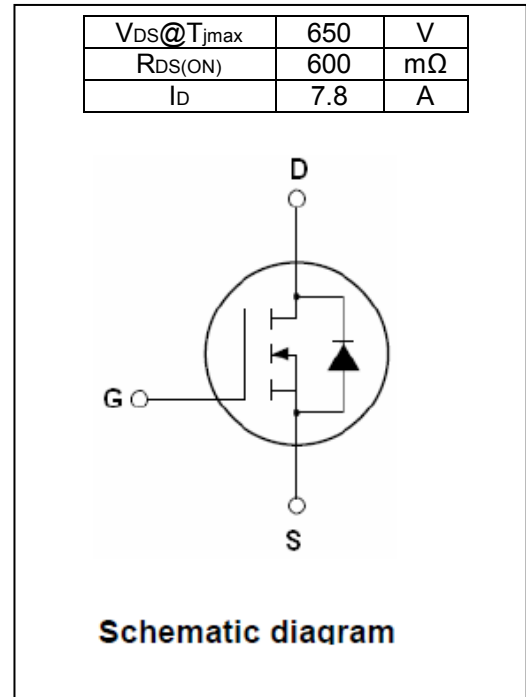
The series of devices use advanced super junction technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

Features:

- ◆ New technology for high voltage device
- ◆ Low on-resistance and low conduction losses
- ◆ Small package
- ◆ Ultra Low Gate Charge cause lower driving requirements
- ◆ 100% Avalanche Tested
- ◆ ROHS compliant

Applications:

- ◆ Power factor correction (PFC)
- ◆ Switched Mode Power Supplies (SMPS)
- ◆ Uninterruptible Power Supply (UPS)



Package Marking And Ordering Information:

Device	Device Package	Marking
SL08N60D	TO-263	SL08N60D
SL08N60	TO-220	SL08N60
SL08N60F	TO-220F	SL08N60F

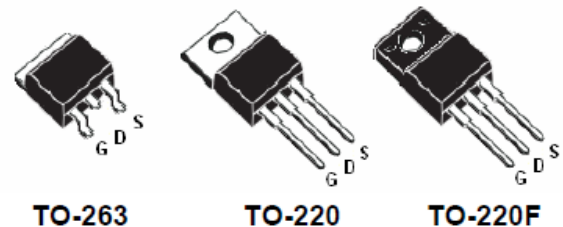


Table 1. Absolute Maximum Ratings (TC=25°C)

Parameter	Symbol	SL08N60D SL08N60	SL08N60F	Unit
Drain-Source Voltage ($V_{GS}=0V$)	V_{DS}	600		V
Gate-Source Voltage ($V_{DS}=0V$)	V_{GS}	± 30		V
Continuous Drain Current at $T_c=25^\circ C$	$I_D (DC)$	7.8	7.8*	A
Continuous Drain Current at $T_c=100^\circ C$	$I_D (DC)$	5	5	A
Pulsed drain current ^(Note 1)	$I_{DM} (pulse)$	23.4	23.4*	A
Drain Source voltage slope, $V_{DS} = 480 V, I_D = 7.8 A, T_j = 125^\circ C$	dv/dt	50		V/ns
Maximum Power Dissipation ($T_c=25^\circ C$) Derate above $25^\circ C$	P_D	83 0.67	32 0.26	W W/ $^\circ C$
Single pulse avalanche energy ^(Note 2)	E_{AS}	230		mJ
Avalanche current ^(Note 1)	I_{AR}	7.8		A
Repetitive Avalanche energy, t_{AR} limited by T_{jmax} ^(Note 1)	E_{AR}	0.5		mJ



Parameter	Symbol	SL08N60D SL08N60	SL08N60F	Unit
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55...+150		°C

* limited by maximum junction temperature

Table 2. Thermal Characteristics

Parameter	Symbol	SL08N60D SL08N60	SL08N60F	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R _{thJC}	1.5	3.9	°C/W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	80	°C/W

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Value			Unit
			Min.	Typ.	Max.	
On / Off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	600			V
Zero Gate Voltage Drain Current (Tc=25°C)	I _{DSS}	V _{DS} =600V, V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current (Tc=125°C)	I _{DSS}	V _{DS} =600V, V _{GS} =0V			100	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2.5	3	3.5	V
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =4.5A		540	600	mΩ
Dynamic Characteristics						
Forward Transconductance	g _{FS}	V _{DS} = 20V, I _D = 4.5A		6		S
Input Capacitance	C _{iss}	V _{DS} = 50V, V _{GS} =0V, F=1.0MHz		860		pF
Output Capacitance	C _{oss}			68		pF
Reverse Transfer Capacitance	C _{rss}			5		pF
Total Gate Charge	Q _g	V _{DS} = 480V, I _D =7.8A, V _{GS} =10V		19	27	nC
Gate-Source Charge	Q _{gs}			3		nC
Gate-Drain Charge	Q _{gd}			6.5		nC
Intrinsic gate resistance	R _G	f = 1 MHz open drain		1.6		Ω
Switching times						
Turn-on Delay Time	t _{d(on)}	V _{DD} = 380V, I _D =7.8A, R _G =12Ω, V _{GS} =10V		6		nS
Turn-on Rise Time	T _r			3.5		nS
Turn-Off Delay Time	t _{d(off)}			60	100	nS
Turn-Off Fall Time	T _r			7	15	nS
Source-Drain Diode Characteristics						
Source-drain current (Body Diode)	I _{SD}	Tc=25°C			7.8	A
Pulsed Source-drain current (Body Diode)	I _{SDM}				23.4	A
Forward on voltage	V _{SD}	T _j =25°C, I _{SD} =7.8A, V _{GS} =0V		0.9	1.3	V
Reverse Recovery Time	T _{rr}	T _j =25°C, I _F =7.8A, di/dt=100A/μs		250		nS
Reverse Recovery Charge	Q _{rr}			2.6		μC
Peak reverse recovery current	I _{rrm}			21		A

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature
 2. T_j=25°C, V_{DD}=50V, V_G=10V, R_e=25Ω

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure1. Safe operating area

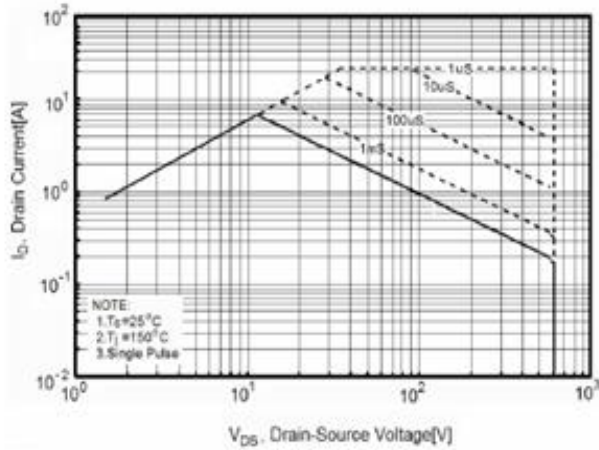


Figure2. Safe operating area for SL08N60F

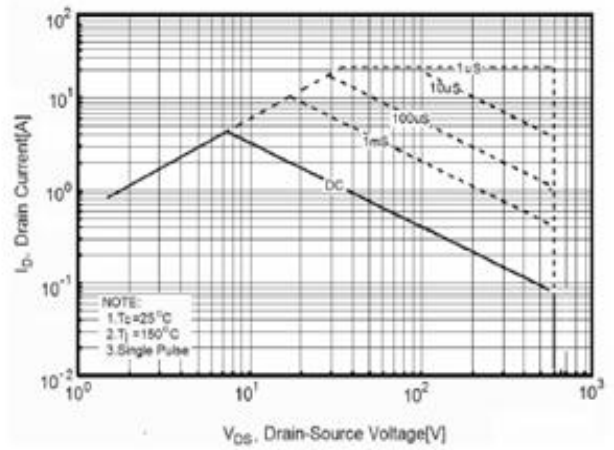


Figure3. Source-Drain Diode Forward Voltage

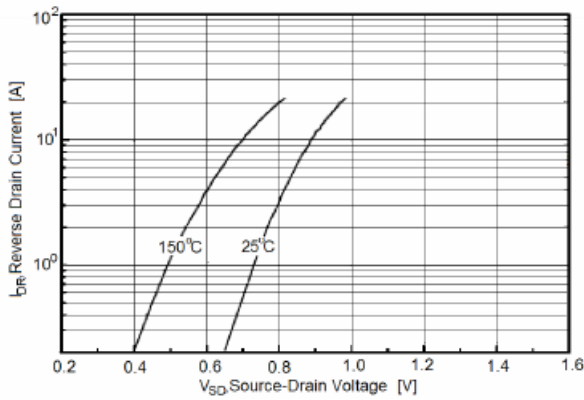


Figure4. Output characteristics

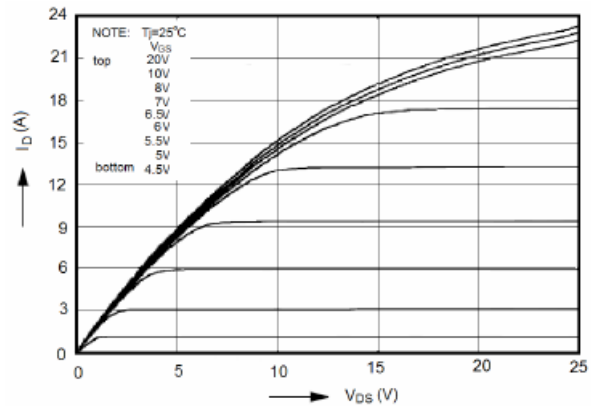


Figure5. Transfer characteristics

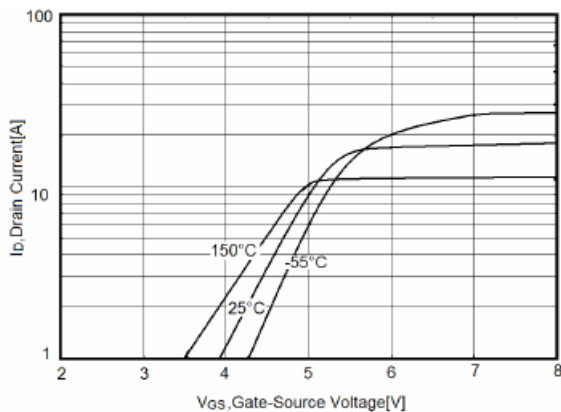
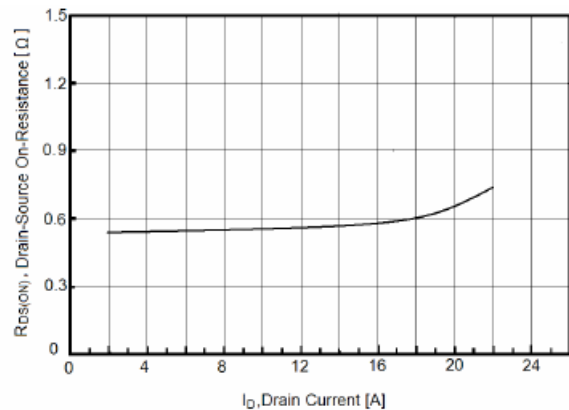


Figure6. Static drain-source on resistance



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves) continued

Figure7. $R_{DS(ON)}$ vs Junction Temperature

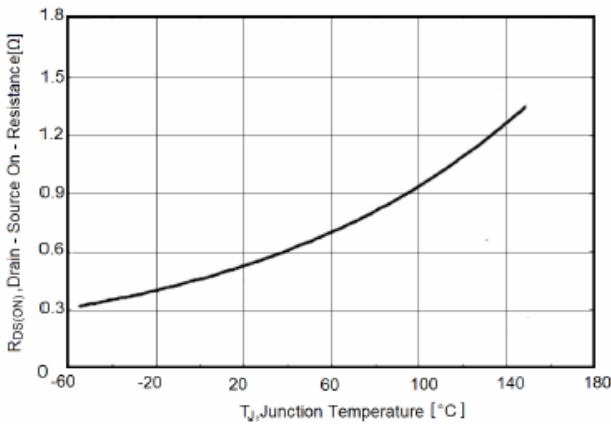


Figure8. BV_{DSS} vs Junction Temperature

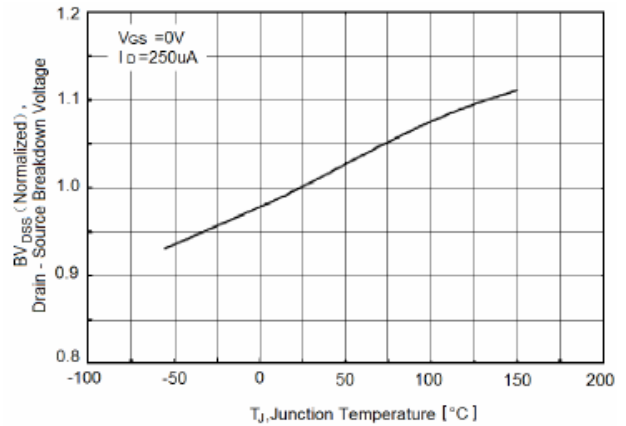


Figure9. Maximum I_D vs Junction Temperature

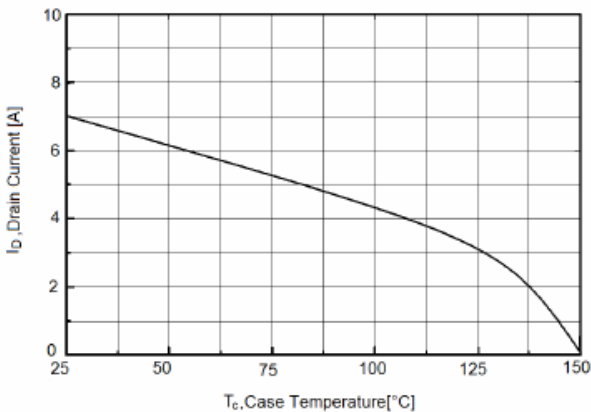


Figure10. Gate charge waveforms

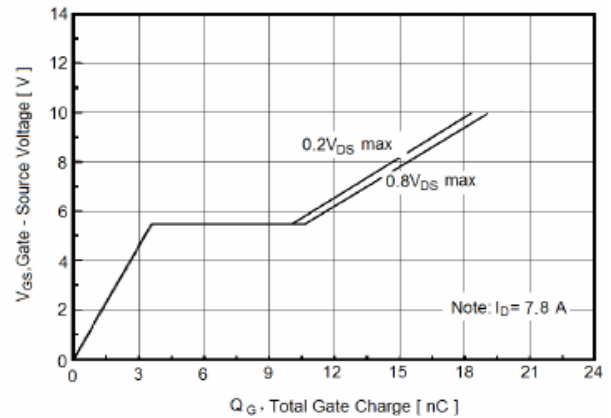


Figure11. Capacitance

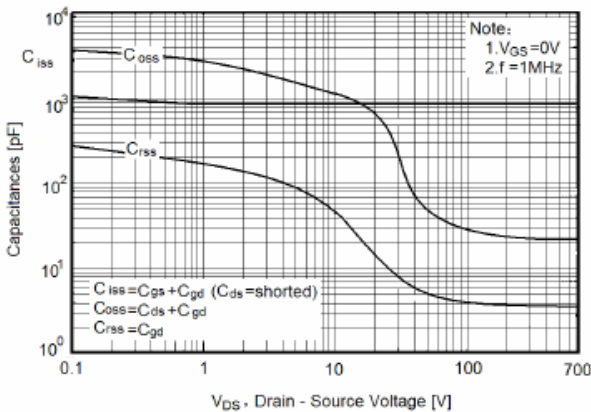
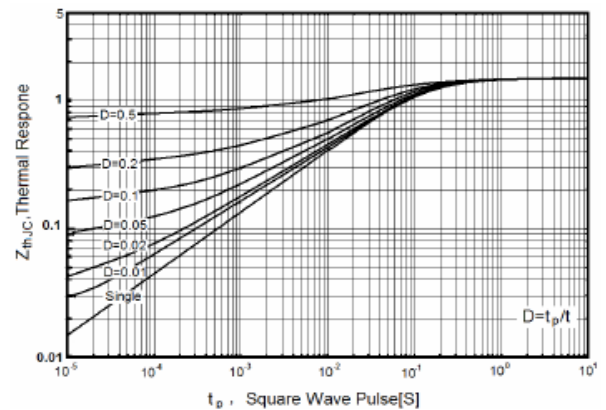


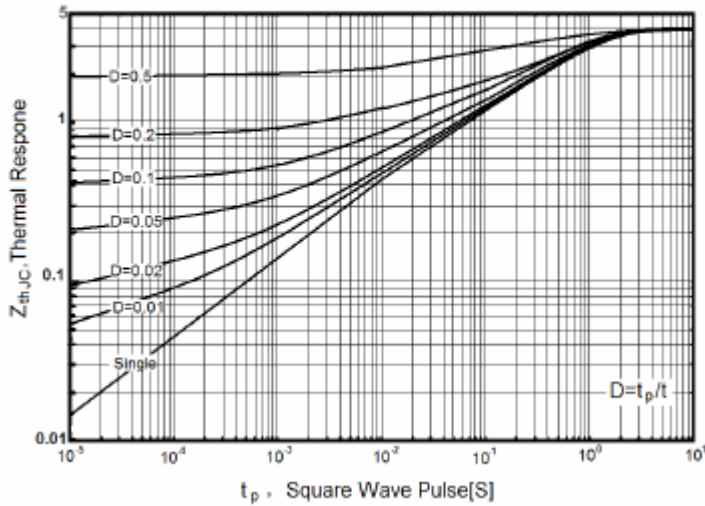
Figure12. Transient Thermal Impedance





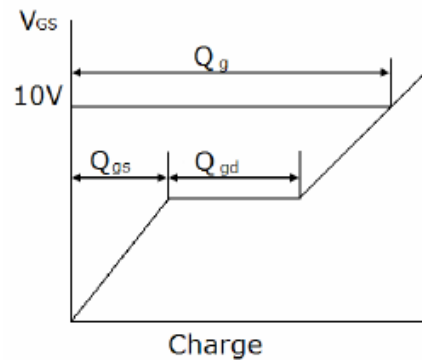
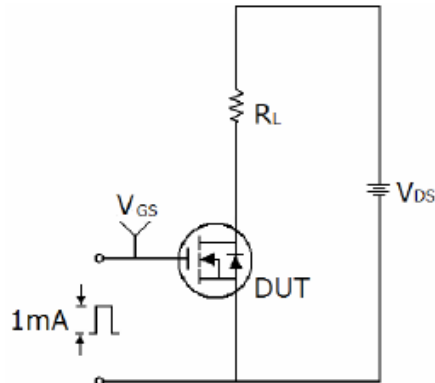
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves) continued

Figure13 . Transient Thermal Impedance for SL08N60F

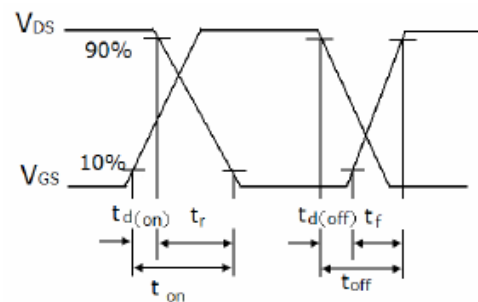
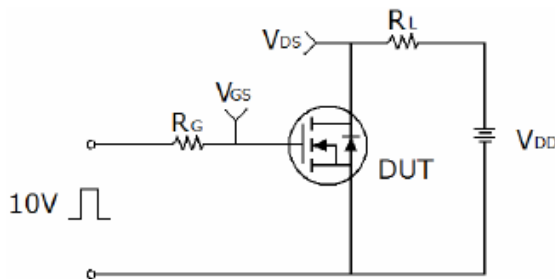


TEST CIRCUIT

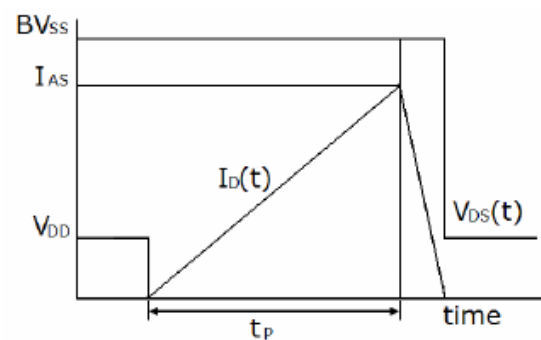
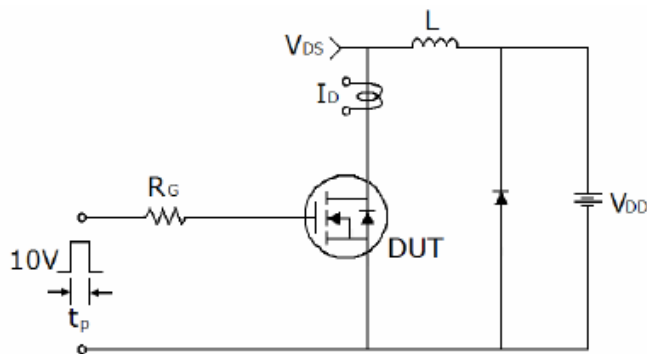
1) Gate charge test circuit & Waveform



2) Switch Time Test Circuit:

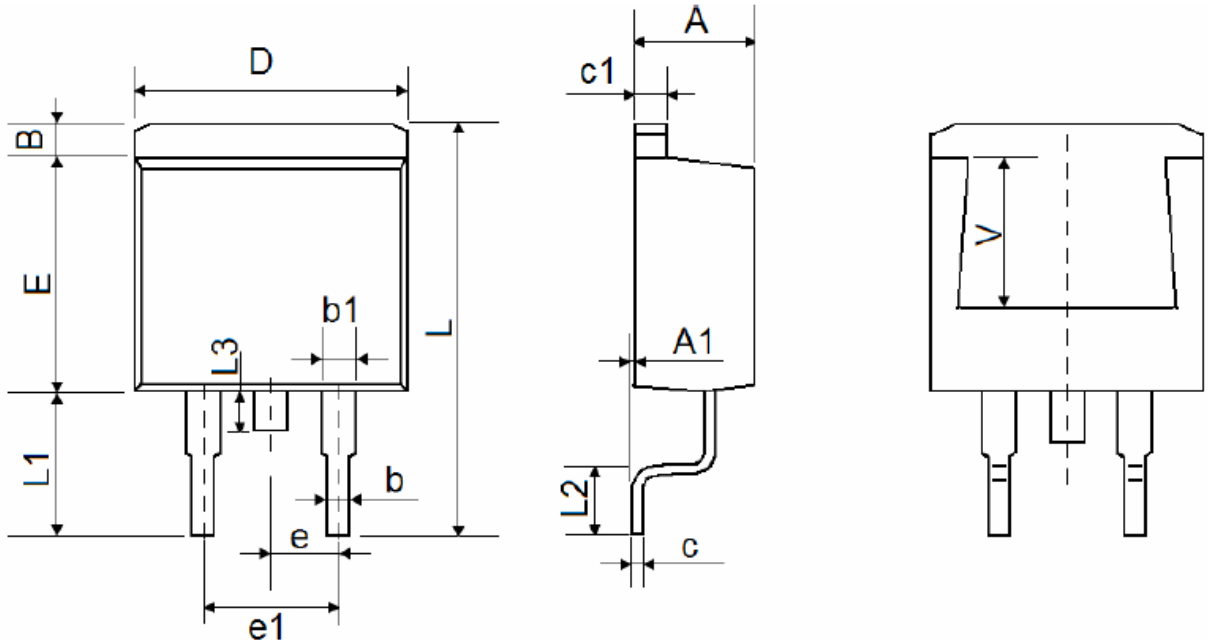


3) Unclamped Inductive Switching Test Circuit & Waveforms



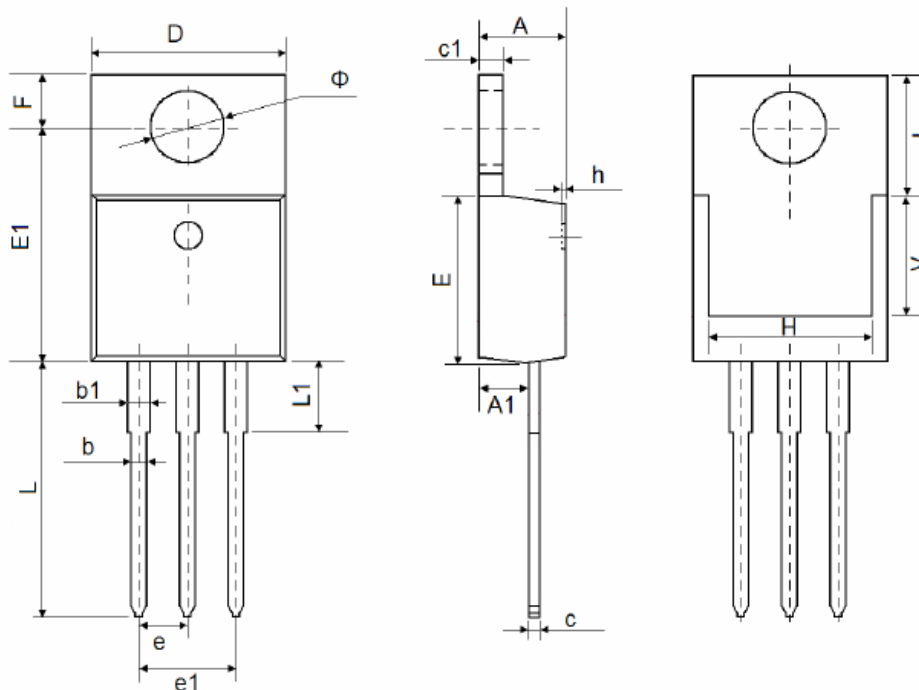


TO-263-2L Package Information



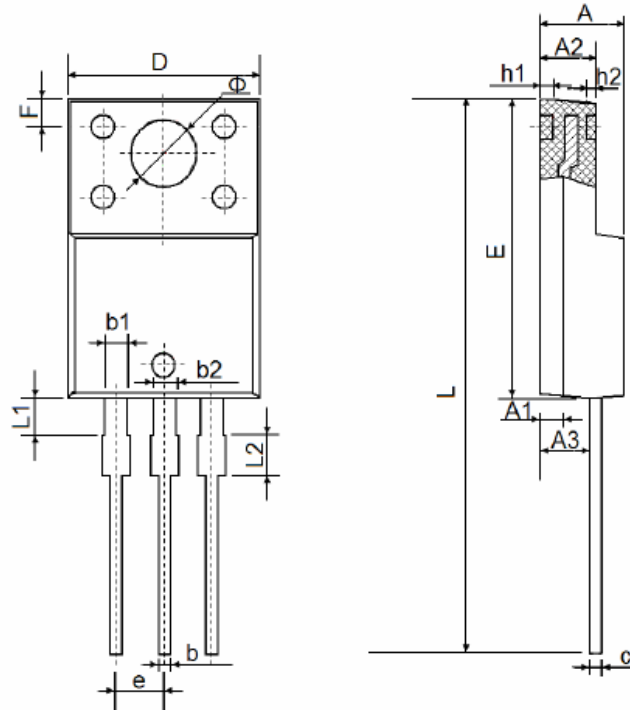
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.470	4.670	0.176	0.184
A1	0.000	0.150	0.000	0.006
B	1.170	1.370	0.046	0.054
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
L	15.050	15.450	0.593	0.608
L1	5.080	5.480	0.200	0.216
L2	2.340	2.740	0.092	0.108
L3	1.300	1.700	0.051	0.067
V	5.600 REF		0.220 REF	

TO-220-3L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.470	4.670	0.176	0.184
A1	2.520	2.820	0.099	0.111
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	10.010	10.350	0.394	0.407
E	8.500	8.900	0.335	0.350
E1	12.060	12.460	0.475	0.491
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
F	2.590	2.890	0.102	0.114
H	8.440 REF.		0.332 REF.	
h	0.000	0.300	0.000	0.012
L	13.400	13.800	0.528	0.543
L1	3.560	3.960	0.140	0.156
V	6.060 REF.		0.239 REF.	
I	6.600 REF.		0.260 REF.	
Φ	3.735	3.935	0.147	0.155

TO-220F Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.300	4.700	0.169	0.185
A1	1.300REF		0.051REF	
A2	2.800	3.200	0.110	0.126
A3	2.500	2.900	0.098	0.114
b	0.500	0.750	0.020	0.030
b1	1.100	1.350	0.043	0.053
b2	1.500	1.750	0.059	0.069
c	0.500	0.750	0.020	0.030
D	9.960	10.360	0.392	0.408
E	14.800	15.200	0.583	0.598
e	2.540TYP.		0.100TYP	
F	2.700REF		0.106REF	
Φ	3.500REF		0.138REF	
h1	0.800REF		0.031REF	
h2	0.500REF		0.020REF	
L	28.000	28.400	1.102	1.118
L1	1.700	1.900	0.067	0.075
L2	1.900	2.100	0.075	0.083